Units in: mm

## TOSHIBA LASER DAIODE

## TOLD9462MD

## InGaAIP LD

Light Source for DVD Application

·Lasing Wavelength :  $\lambda p = 650 \text{nm} \text{ (typ.)}$ 

· Optical Output Power

:Po=7mW

·Operation Case Temperature : Tc=-10~70°C

• PIN CONNECTION



- 1. LASER DIODE ANODE
- 2. LASER DIODE CATHODE PHOTODIODE CATHODE
- 3. PHOTODIODE ANODE

Maximum Ratings (Tc=25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Optical Output Power(CW)	Ро	7	mW
LD Reverse Voltage	V <sub>R. (L.D)</sub>	2	V
PD Reverse Voltage	V <sub>R (PD)</sub>	3 0	V
Operation Case Temperature	$T_{\rm c}$	-10 ∼ 70	°C
Storage Temperature	Tste	-40 ∼ 85	°C

\$5.6<sup>+0</sup>\_-0.03 Beam Emission Surface  $\phi 3.55 \pm 0.1$ (\$1.8) Window Glass LD Chip denotes typical value

EIAJ 15-4A1 TOSHIBA

Optical-Electrical Characteristics(Tc=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Threshold Current	Ith	CW Operation	_	23	40	mA
Operation Current	Iop	Po=5mW	_	30	45	m.A
Operation Voltage	Vop	Po=5mW	_	2.2	2.5	V
Lasing Wavelength	λp	Po=5mW	640	650	660	nm
Beam Divergence	θ	Po=5mW	5	8	11	0
	$\theta \bot$	Po=5mW	24	28	32	0
Monitor Current	Im	Po=5mW	0.07	0.18	0.35	mA
PD Dark Current	I D (PD)	VR=5V	_	_	100	nA
PD Total Capacitance	C <sub>T (PD)</sub>	VR=5V, f=1MHz		_	20	рF

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●Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

●The information contained herein is subject to change without notice.



TOLD9462MD

## PRECAUTIONS:

- Be careful never to exceed, even momentarily, the maximum ratings. The laser diode is damaged by spike current which can be generated when switching the power ON or OFF. Before activating laser diodes, check the transient state of the power supply to ensure that it will not cause the laser diode to exceed the maximum ratings.
- 2. Effective heat sinking should be performed, because temperature rise causes decrease of optical output power. Use a thermal radiator to reduce the temperature rise.
- 3. Prevent electrostatic discharge and electric spike which may damage the laser diode. The following precautions should be taken when using a laser diode.
  - 1. Set the electrical potential of the work bench to be the same as that of the power supply ground line.
  - 2. Soldering irons and the operator's body should be grounded.
  - 3. Do not operate equipment which may generate high frequency surge energy near the laser diode.
- 4. Do not apply excessive stress between the package and the leads, because it deteriorates hermeticity. If the leads are formed, soldering should be performed after lead forming. Soldering temperature:260°CMAX Soldering time:5 sec MAX (soldering portion of leads: up to 2mm from the body of the device)
- 5. Take care not to touch the window glass. Contamination and scratches on the window glass surface will result in decreased optical output power and distorted far-field patterns.
- 6. Do not look at the laser beam directly or through lenses when the laser diode is activated. The laser beam emitted by laser diode is harmful if aimed directly into human eye.
- 7. Toshiba Visible Laser Diodes are available in two types of carton to which the following warning labels are attached:-
  - 1. Envelope Package(1 piece):warning labels are included on the reverse side of the individual envelope
  - 2. Tray Package(200 pieces)warning labels are attached to the top of the external carton that contains the tray. \*due to the small size of the laser diodes, the warning labels are placed on the laser diode packaging and not on the individual laser diodes.





CERTIFICATION
The Product Complies with
21 CFR 1040,10 and 1040,11.
Model Number:
MANUFACTURED
TOSHIBA CORPRATION
11 PRINCIPL OCCUPATION